



LTST-G683RGBW Spec No.: DS22-2011-0302

Effective Date: 10/14/2016 Revision: B



BNS-OD-FC001/A4

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SMD LED LTST-G683RGBW

1. Description

SMD LEDs from Lite-On are available in miniature sizes and special configurations for automated PC board assembly and space-sensitive applications. These SMD LEDs are suitable for use in a wide variety of electronic equipment, including cordless and cellular phones, notebook computers, network systems, home appliances, and indoor signboard applications.

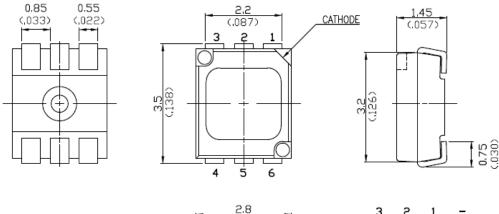
1.1 Features

- Meet ROHS
- Package in 8mm tape on 7" diameter reels
- EIA STD package
- I.C. compatible
- Compatible with automatic placement equipment
- Compatible with infrared reflow solder process
- Preconditioning: accelerate to JEDEC level 3

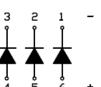
1.2 Applications

- Telecommunication, Office automation, home appliances, industrial equipment
- Status indicator
- Signal and Symbol Luminary
- Front panel backlighting

2. Package Dimensions







Part No.	Lens Color	Source Color	Pin Assignment
		InGaN Blue	1, 6
LTST-G683RGBW	White Diffused	InGaN Green	2, 5
		AllnGaP Red	3, 4

Notes:

- 1. All dimensions are in millimeters.
- 2. Tolerance is ±0.2 mm (.008") unless otherwise noted.



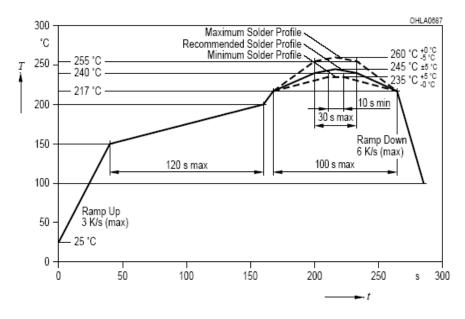
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3. Rating and Characteristics

3.1 Absolute Maximum Ratings at Ta=25°C

Deservator	L	11-14		
Parameter	Red	Green	Blue	Unit
Power Dissipation	72	80	80	mW
Peak Forward Current (1/10 Duty Cycle, 0.1ms Pulse Width)	80	100	100	mA
DC Forward Current	30	20	20	mA
Operating Temperature Range	-40°C to + 85°C			
Storage Temperature Range		-40°C to +	100°C	

3.2 Suggest IR Reflow Condition for Pb Free Process:



IR-Reflow Soldering Profile for lead free soldering (Acc. to J-STD-020B)

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3.3 Electrical / Optical Characteristics at Ta=25°C

Provider		LTST-G683RGBW			11-14		
Parameter	Symbol		Red	Green	Blue	Unit.	Test Condition
		Min.	90	355	180		I _F = 20mA Note 1
Luminous Intensity	IV	Тур.	-	-	-	mcd	
		Max.	224	710	355		
Viewing Angle	20 _{1/2}	Тур.		120		deg	Note 2 (Fig.5)
Dominant Wayslangth	2	Min.	624	520	465	nm	I _F = 20mA
Dominant Wavelength	λ_d	Max.	636	530	475		Note 3
Peak Emission Wavelength	λΡ	Тур.	639	518	465	nm	Measurement @Peak (Fig.1)
Spectral Line Half-Width	Δλ	Тур.	20	35	25	nm	-
Forward Voltage	V	Min.	1.8	2.8	2.8	V	I _F = 20mA
Forward Voltage	V _F	Max.	2.4	3.8	3.8	V	Note 4
Reverse Current	IR Ma	Max.	x. 10				$V_R = 5V$
Neverse Guilent		ividX.			μA	Note 5	

Notes:

- 1. Luminous intensity is measured with a light sensor and filter combination that approximates the CIE eye-response curve
- 2. 01/2 is the off-axis angle at which the luminous intensity is half the axial luminous intensity.
- The dominant wavelength, λd is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device
- 4. Forward Voltage Tolerance is +/- 0.1 volt.
- 5. Reverse voltage (VR) condition is applied to IR test only. The device is not designed for reverse operation.



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4. Bin Code List

• Luminous Intensity

	Lun	ninous Intensi	ty U	nit : mcd @20	mA	
Die Code	R	ed	Green		BI	ue
Bin Code	Min	Max	Min	Max	Min	Max
A1			140	180		
A2			355	450	180	224
A3			300	450	224	280
A4					280	355
A5					140	180
A6	90	112	450	560	180	224
A7	90	112	450	560	224	280
A8					280	355
A9		56			140	180
A10			560	560 710	180	224
A11			500		224	280
A12					280	355
B1					140	180
B2			355	450	180	224
B3			555 450	450	224	280
B4					280	355
B5					140	180
B6	112	140	450	560	180	224
B7	112	140	400	500	224	280
B8					280	355
B9					140	180
B10			560	710	180	224
B11			500	710	224	280
B12					280	355

Tolerance on each Intensity bin is +/-11%

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• Luminous Intensity

	Lun	ninous Intensi	ty L	Init : mcd @20	mA									
Bin Code	Red Green		Green		ue									
Bin Code	Min	Max	Min	Max	Min	Max								
C1					140	180								
C2	2	450	180	224										
C3			355	450	224	280								
C4					280	355								
C5					140	180								
C6	140	400	450	500	180	224								
C7	140	180	450	560	224	280								
C8					280	355								
C9					140	180								
C10			560	60 710	180	224								
C11					224	280								
C12					280	355								
D1					140	180								
D2			355		180	224								
D3				300	300	355	355	300	355	300	300	355	450	224
D4					280	355								
D5					140	180								
D6	100	224	450	ECO	180	224								
D7	180	224	450	560	224	280								
D8					280	355								
D9					140	180								
D10			E00	740	180	224								
D11			560	710	224	280								
D12					280	355								

Tolerance on each Intensity bin is +/-11%



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Dominant Wavelength

Dominant Wavelength Unit : nm @20mA						
Die Code	R	Red Green		Blue		
Bin Code	Min	Max	Min	Max	Min	Max
E1			520	525	465	470
E2	604	626			470	475
E3	624	636		530	465	470
E4			525		470	475

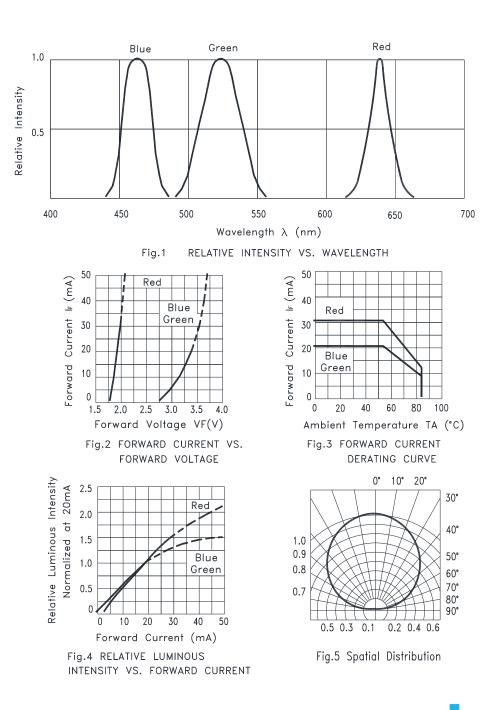
Tolerance for each Dominate Wavelength Bin is +/- 1nm





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5. Typical Electrical / Optical Characteristics Curves.



(25°C Ambient Temperature Unless Otherwise Noted)

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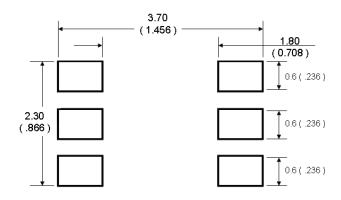
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6. User Guide

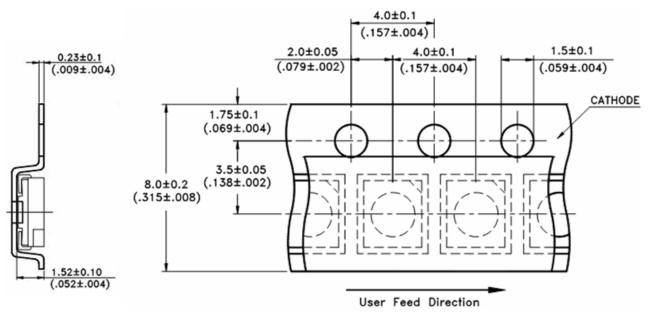
6.1 Cleaning

Do not use unspecified chemical liquid to clean LED they could harm the package. If cleaning is necessary, immerse the LED in ethyl alcohol or isopropyl alcohol at normal temperature for less one minute.

6.2 Recommend Printed Circuit Board Attachment Pad



6.3 Package Dimensions of Tape And Reel



Note:

1. All dimensions are in millimeters (inches).

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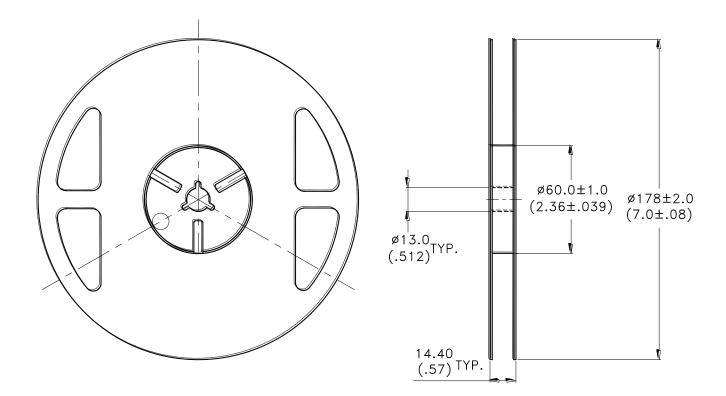
Part No. : LTST-G683RGBW

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6.4 Package Dimensions of Reel



Notes:

- 1. Empty component pockets sealed with top cover tape.
- 2. 7 inch reel 2000 pieces per reel.
- 3. Minimum packing quantity is 500 pieces for remainders.
- 4. The maximum number of consecutive missing lamps is two.
- 5. In accordance with EIA-481-1-B specifications.



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7. Cautions

7.1 Application

The LEDs described here are intended to be used for ordinary electronic equipment (such as office equipment, communication equipment and household applications).Consult Liteon's Sales in advance for information on applications in which exceptional reliability is required, particularly when the failure or malfunction of the LEDs may directly jeopardize life or health (such as in aviation, transportation, traffic control equipment, medical and life support systems and safety devices).

7.2 Storage

The package is sealed:

The LEDs should be stored at 30°C or less and 70%RH or less. And the LEDs are limited to use within one year, while the LEDs is packed in moisture-proof package with the desiccants inside.

The package is opened:

The storage ambient for the LEDs should not exceed 30°C temperature and 60% relative humidity.

It is recommended that LEDs out of their original packaging are IR-reflowed within 168hrs.

For extended storage out of their original packaging, it is recommended that the LEDs be stored in a sealed container with appropriate desiccant, or in a desiccators with nitrogen ambient.

LEDs stored out of their original packaging for more than 168hrs should be baked at about 60 °C for at least 48 hours before solder assembly.

7.3 Cleaning

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED if necessary.

7.4 Soldering

Recommended soldering conditions:

Reflo	w soldering	Soldering iron		
Pre-heat	150~200°C	Temperature	300°C Max.	
Pre-heat time 120 sec. Max.		Soldering time	3 sec. Max.	
Peak temperature 260°C Max.			(one time only)	
Soldering time	10 sec. Max.(Max. two times)			

Notes:

Because different board designs use different number and types of devices, solder pastes, reflow ovens, and circuit boards, no single temperature profile works for all possible combinations.

However, you can successfully mount your packages to the PCB by following the proper guidelines and PCB-specific characterization.

LITE-ON Runs both component-level verification using in-house **KYRAMX98** reflow chambers and board-level assembly. The results of this testing are verified through post-reflow reliability testing.Profiles used at LITE-ON are based on JEDEC standards to ensure that all packages can be successfully and reliably surface mounted.

Figure on page3 shows a sample temperature profile compliant to JEDEC standards. You can use this example as a generic target to set up your reflow process. You should adhere to the JEDEC profile limits as well as specifications and recommendations from the solder paste manufacturer to avoid damaging the device and create a reliable solder joint.

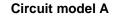


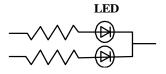


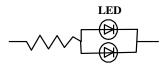
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7.5 Drive Method

A LED is a current-operated device. In order to ensure intensity uniformity on multiple LEDs connected in parallel in an application, it is recommended that a current limiting resistor be incorporated in the drive circuit, in series with each LED as shown in Circuit A below.







Circuit model B

- (A) Recommended circuit.
- (B) The brightness of each LED might appear different due to the differences in the I-V characteristics of those LEDs.

7.6 ESD (Electrostatic Discharge)

Static Electricity or power surge will damage the LED. Suggestions to prevent ESD damage:

- Use of a conductive wrist band or anti-electrostatic glove when handling these LEDs.
- All devices, equipment, and machinery must be properly grounded.
- Work tables, storage racks, etc. should be properly grounded.
- Use ion blower to neutralize the static charge which might have built up on surface of the LED's plastic lens as a result of friction between LEDs during storage and handling.

ESD-damaged LEDs will exhibit abnormal characteristics such as high reverse leakage current, low forward voltage, or "no lightup" at low currents.

To verify for ESD damage, check for "lightup" and Vf of the suspect LEDs at low currents.

The Vf of " good " LEDs should be >2.0V@0.1mA for InGaN product and >1.4V@0.1mA for AlInGaP product.





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8. Reliability Test

No.	Test item	Test condition	Reference standard
1	Resistance to soldering heat	Tsld = 260°C, 10sec. 3 times	JEITA ED-4701 300 301
2	Solderability	Tsld=245 \pm 5°C (Lead Free Solder, Coverage \geq 95% of the dipped surface)	JEITA ED-4701 300 303
3	Thermal Shock	85 ± 5°C ~ -30°C ± 5°C 30min 30min 100cycles	JEITA ED-4701 300 307
4	Temperature Cycle	-55°C ~ 25°C ~ 100°C ~ 25°C 30min 5min 30min 5min 100cycles	JEITA ED-4701 100 105
5	High Temperature Storage	100°C 1000hrs	JEITA ED-4701 200 201
6	Low Temperature Storage	-55°C 1000hrs	JEITA ED-4701 200 202
7	Temperature Humidity Storage	60°C/90%RH 300hrs	JEITA ED-4701 100 103
8	Room temp life test	25°C, IF: Max current , 1000hrs	

9. Others

The appearance and specifications of the product may be modified for improvement without prior notice.





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10. Suggested Checking List

Training and Certification

- 1. Everyone working in a static-safe area is ESD-certified?
- 2. Training records kept and re-certification dates monitored?

Static-Safe Workstation & Work Areas

- 1. Static-safe workstation or work-areas have ESD signs?
- 2. All surfaces and objects at all static-safe workstation and within 1 ft measure less than 100V?
- 3. All ionizer activated, positioned towards the units?
- 4. Each work surface mats grounding is good?

Personnel Grounding

- 1. Every person (including visitors) handling ESD sensitive (ESDS) items wears wrist strap, heel strap or conductive shoes with conductive flooring?
- 2. If conductive footwear used, conductive flooring also present where operator stand or walk?
- 3. Garments, hairs or anything closer than 1 ft to ESD items measure less than 100V*?
- 4. Every wrist strap or heel strap/conductive shoes checked daily and result recorded for all DLs?
- 5. All wrist strap or heel strap checkers calibration up to date?

Note: *50V for InGaN LED.

Device Handling

- 1. Every ESDS items identified by EIA-471 labels on item or packaging?
- 2. All ESDS items completely inside properly closed static-shielding containers when not at static-safe workstation?
- 3. No static charge generators (e.g. plastics) inside shielding containers with ESDS items?
- 4. All flexible conductive and dissipative package materials inspected before reuse or recycles?

Others

- 1. Audit result reported to entity ESD control coordinator?
- 2. Corrective action from previous audits completed?
- 3. Are audit records complete and on file?

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